LNJ311G8PRA

Surface Mounting Chip LED

3216 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol		Unit	
Power dissipation	P_{D}	50	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	T _{opr} -30 to +85		
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

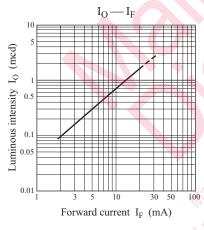
■ Lighting Color

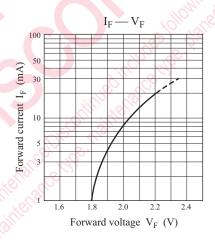
• Pure Green

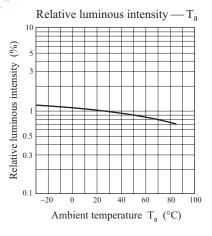
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

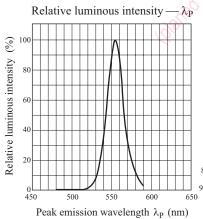
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_F = 10 \text{ mA}$	0.25	0.70	0,	mcd
Reverse current	I_R	$V_R = 4 V$	111	50,0	10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	9110	2.03	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	le le	555		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	OLILI	20		nm

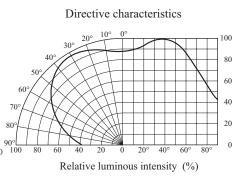
Note) *: Measurement tolerance: ±20%

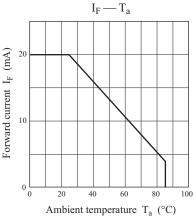








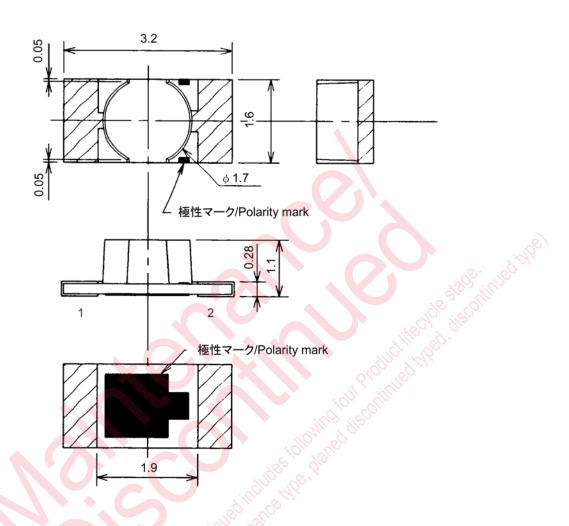




LNJ311G8PRA Panasonic

■ Package (Unit: mm)

KLTFTN2K1100



- Pin name
 - 1: Anode
 - 2: Cathode

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